

VDIC ASYNCHRONOUS STATIC RAM

VDSR32M32XS68XX8V12 USER MANUAL

Version : B3

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VDIC-SRAM

HIGH-SPEED 1M×32bit

ASYNCHRONOUS STATIC RAM

1 Description

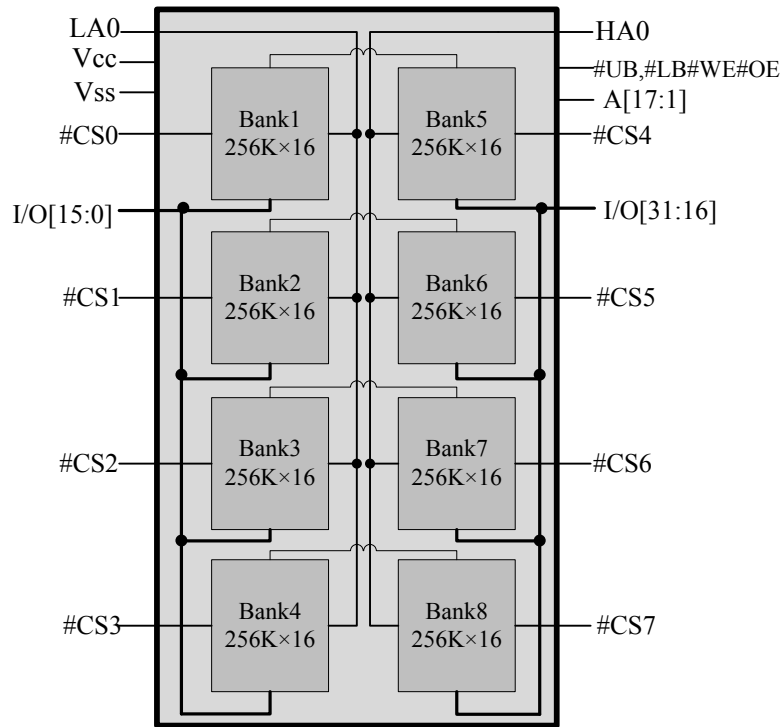
The VDSR32M32XS68XX8V12 is a high-speed access time, high-density Static Random Access Memory containing 33,554,332 bits. Manufactured with VDIC Very Dense SiP technology, this SiP module stacks eight 4-Mbit SRAM dies employing CMOS process (6-transistor memory cell). It is organized as four independent blocks of 256K x 32bit wide data interface. Each block can be selected separately with dedicated #CSn. Low interconnect parasitic capacitance of the stacking technology, by reducing the connection length, allows this SRAM module to be useful for a variety of high bandwidth, high performance and high density memory system applications.

The VDSR32M32XS68XX8V12 is available in 68-pin SOP package.

2 Features

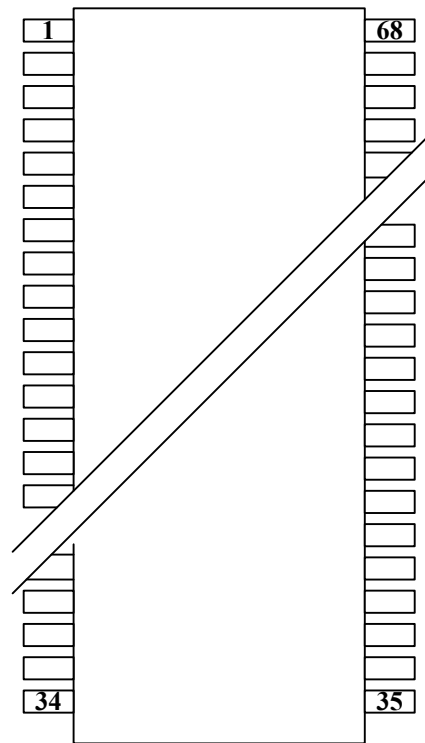
- Single 3.3V±0.3V power supply
- Stack of eight 4Mbit SRAM
- Organized as 4 blocks of 256K×32bit
- Eight independent Chip Select, #CS0, #CS1, #CS2, #CS3, #CS4, #CS5, #CS6, #CS7
- All inputs and outputs directly TTL compatible
- Equal Access and Cycle times
- Fast Access time: 15ns
- Max. Operating current: 290 mA
- Max. Standby TTL current: 320 mA
- Max. Standby CMOS current: 40mA
- No clock or timing strobe required
- CenterVcc and Vss type pin out
- 68-lead SOP Type II package

3 Block Diagram



4 Pin Descriptions

Pin Id	Pin #		Pin Id
#CS5	1	68	#CS6
I/O18	2	67	#CS3
I/O17	3	66	I/O28
I/O16	4	65	I/O29
#CS1	5	64	I/O30
HA0	6	63	I/O31
LA0	7	62	A17
A1	8	61	A16
A2	9	60	A15
A3	10	59	#OE
A4	11	58	#UB
#CS0	12	57	#LB
I/O0	13	56	I/O15
I/O1	14	55	I/O14
I/O2	15	54	I/O13
I/O3	16	53	I/O12
VCC	17	52	VSS
VSS	18	51	VCC
I/O4	19	50	I/O11
I/O5	20	49	I/O10
I/O6	21	48	I/O9
I/O7	22	47	I/O8
#WE	23	46	#CS2
A5	24	45	A14
A6	25	44	A13
A7	26	43	A12
A8	27	42	A11
A9	28	41	A10
I/O23	29	40	I/O24
I/O22	30	39	I/O25
I/O21	31	38	I/O26
I/O20	32	37	I/O27
I/O19	33	36	#CS4
NC	34	35	#CS7



Pin	Name	Function
#CS0 ~ #CS7	Chip select	Disables or enables memory bank1 ~ bank8 operation
HA0	Upper A0	Latches A0 to bank 5 ~ bank 8
LA0	Lower A0	Latches A0 to bank 1 ~ bank 4
A1 ~ A17	Address	Row/column 18-bit addresses
#WE	Write enable	Enables write operation command to all banks
#OE	Output enable	Enables data output command to all banks
#UB	Upper byte select	Latches upper bytes data(I/O[15:8],I/O[31:24]) to all banks

#LB	Lower byte select	Latches lower bytes data (I/O[7:0],I/O[23:16]) to all banks
I/O0 ~ I/O31	Data input/output	Data inputs/outputs 32-bit wide bus : Data I/O0 to I/O15 activated from bank 1 ~bank4 and Data I/O16 to I/O31 activated from bank 5 ~ bank 8.
Vcc/Vss	Power supply/ground	Power and ground for the input/output buffers and core logic.
NC	No connection	This pin is recommended to be left No Connection on the device.

5 Command Operation

5.1. Absolute Maximum Ratings

Characteristics	Symbol	Maximum ratings	Unit
Voltage on V _{CC} supply relative to V _{SS}	V _{CC}	-0.5 to +4.6	V
Voltage on any pin relative to V _{SS}	V _{IN}	-0.5 to +4.6	V
Power Dissipation	P _D	2	W
Operating Temperature Range	T _{OPR}	-55 to +125	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

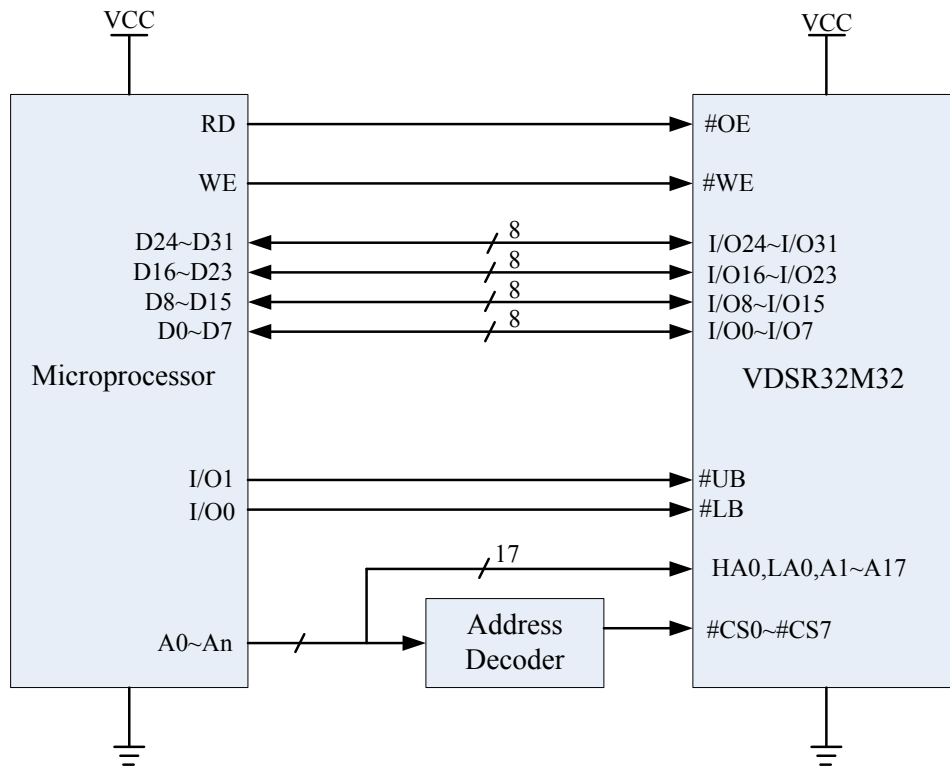
5.2. Recommended DC Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	V _{CC}	3.0	3.3	3.6	V
Input high voltage	V _{IH}	2.0	—	V _{CC} +0.3	V
Input low voltage	V _{IL}	-0.3	—	0.8	V

5.3. DC Electrical Characteristics Over The Operating

Parameter	Symbol	Test Conditions	Min	Max	Unit
Output voltage low level	V _{OL}	V _{CC} =3.6V , I _{OL} =1mA	—	0.4	V
Output voltage high level	V _{OH}	V _{CC} =3.6V, I _{OH} =-0.5mA	2.4	—	V

6 Typical Application



7 Ordering Information

1	2	3	4	5	6	7	8	9	10	11	12	13
<u>VD</u>	<u>SR</u>	<u>32M</u>	<u>32</u>	<u>V</u>	<u>S</u>	<u>68</u>	<u>E</u>	<u>E</u>	<u>8</u>	<u>V</u>	<u>12</u>	-
VDIC												
SRAM												
Capability: 32Mbit												
Bus Width: 32bit												
R= Radiation Data Tested; V= Generic Radiation Data Available												
Package: S=SOP												
68=68 Pin												
Temperature: E=0~70°C;I=-40~85°C;M=-55~125°C;S=Specific												
Quality: E= Sample; B= Industry; M=Military; S= Space												
Stacking Layer:8=8layer												
Power Supply :V=3.3V												
Speed:12= 12ns												
-I, -K or blank space=First Version												

Part Number	Capacity (bit)	Bus Width (bit)	Radiation			Packaging	Temperature (°C)
			TID ¹	SEL ²	SEU ³		
VDSR32M32VS68EE8V12	32M	32	-	-	-	SOP68	0 ~ +70
VDSR32M32VS68IB8V12	32M	32	-	-	-	SOP68	-40 ~ +85
VDSR32M32VS68MB8V12	32M	32	-	-	-	SOP68	-55 ~ +125
VDSR32M32VS68MM8V12	32M	32	-	-	-	SOP68	-55 ~ +125

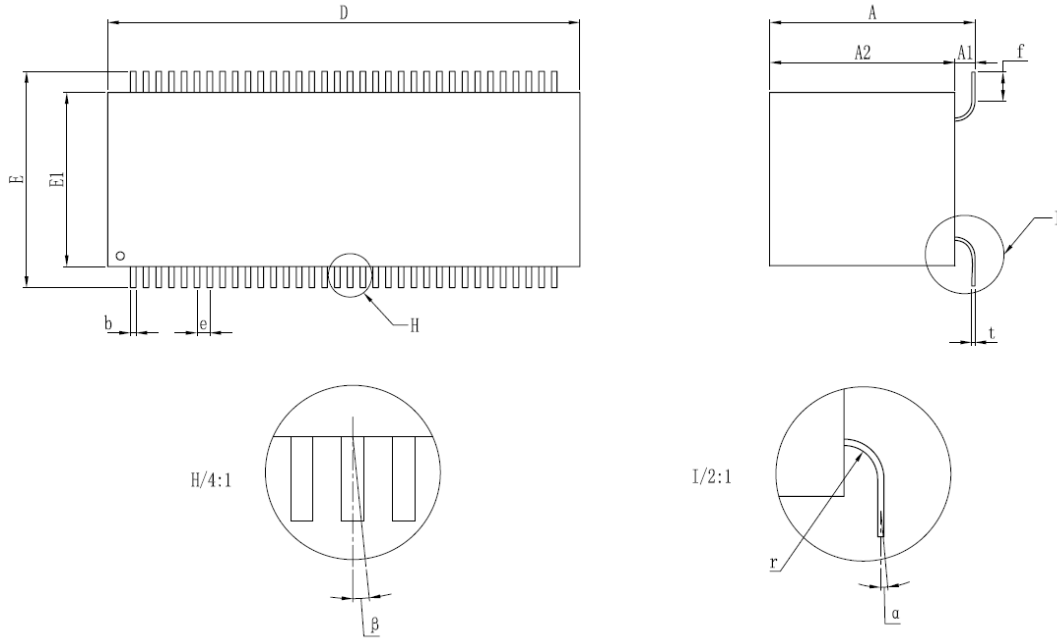
¹ TID: Total Dose (Krad(Si))

² SEL: LET Threshold (Mev.cm²/mg)

³ SEU:SEU Threshold (Mev.cm²/mg)

VDSR32M32RS68MS8V12	32M	32	100	99.8	0.7	SOP68	-55 ~ + 125
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8 Package Dimensions



	Min	Max
A	12.60	13.20
A2	11.40	11.90
D	29.50	29.90
E	13.40	13.80
E1	10.80	11.20
f	2.00	
b	0.35	
e	0.80	
r	1.00	
t	0.20	
α	≤3°	
β	≤3°	

NOTE : 1. Unit : mm

2. A1= A - A2

9 REVISION HISTORY

Revision	Date	Description of Change
A0	Nov 3,2015	First Created
A1	Mar 14,2016	Modified PIN DESCRIPTIONS
A2	Aug 23,2016	Modified ORDERING INFORMATION
A3	Jan 9,2017	Modified PACKAGE DIMENSIONS
A4	Oct.25,2017	Modified Features
A5	Nov.15.2017	Modified FEATURES
B0	Dec,20.2017	Changed company's name to Zhuhai Orbita Aerospace Science & Technology Co., Ltd
B1	Apr 13,2018	Add or reduce chapters
B2	Oct 18,2018	Revising pin descriptions
B3	Apr 22 2019	Change Storage Temperature Range